THEREOF
Inventor: Joo Ho LEE
Docket No. 2336-248

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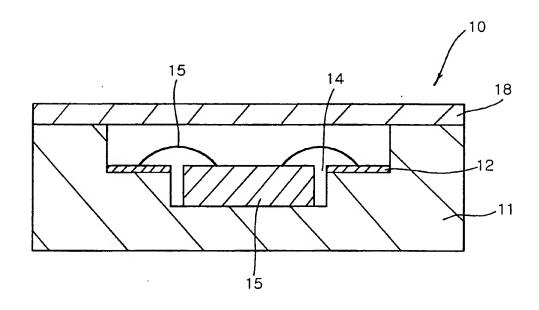


FIG. 1
PRIOR ART

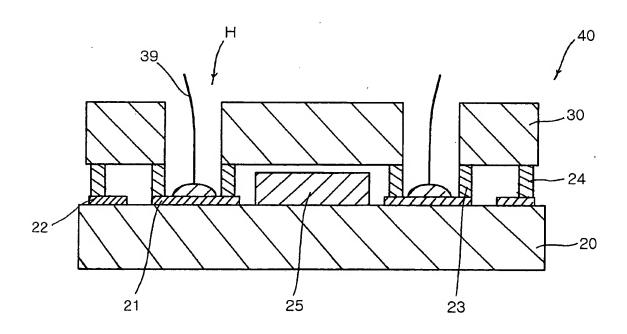
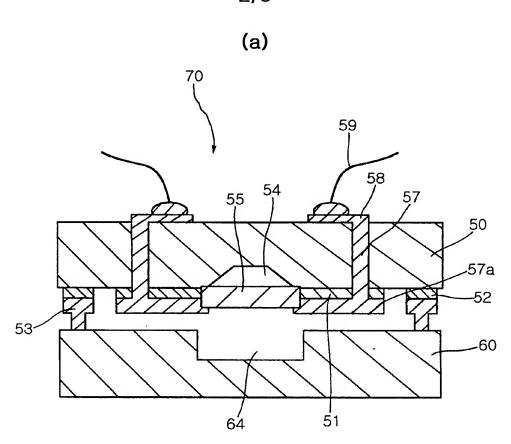


FIG. 2 PRIOR ART

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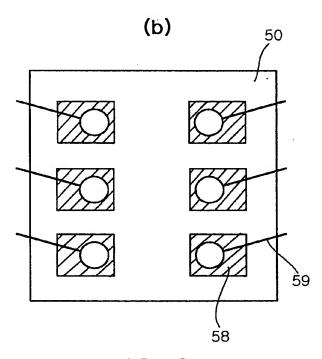


FIG. 3

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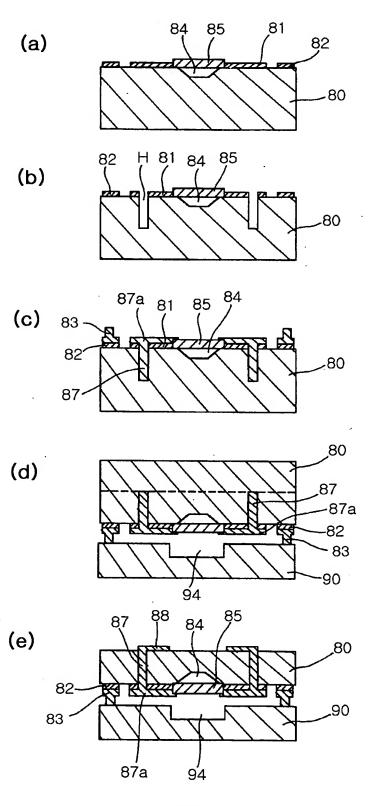


FIG. 4

## WAFER LEVEL PACKAGE FOR MICRO DEVICE AND MANUFACTURING METHOD . THEREOF

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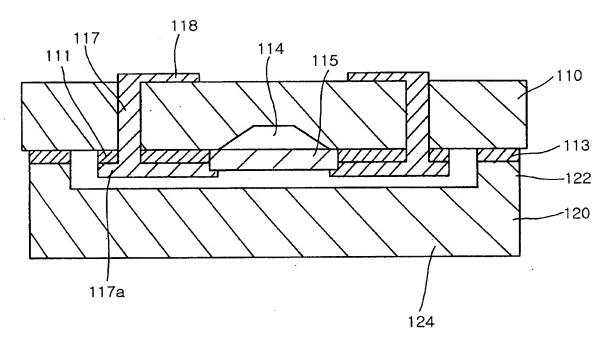
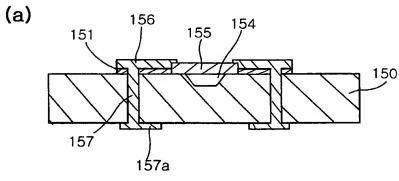
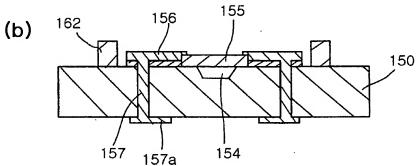


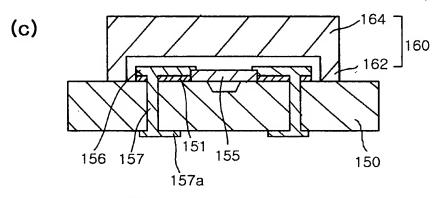
FIG. 5

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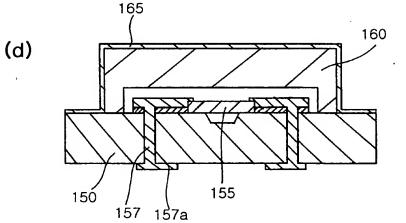


FIG. 6